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CLAIMS

Sub 1 A solid state image sensor device comprising:
an image sensing cell array portion including a
plurality of unit cells, the unit cells being arranged
in a matrix form on a semiconductor substrate, the
image sensing cell array portion having a photo-
sensitive pixel region and an optical black pixel
region, the unit cells of the photo-sensitive pixel
region for sensing an image, and the unit cells of the
optical black pixel region for defining an optical
black level;

15 a selecting circuit for selecting the unit cells
of the image sensing cell array portion in a unit of
one horizontal line of the image sensing cell array
portion;

a plurality of vertical signal lines on which signals are read out from the unit cells selected by the selecting circuit; and

20 a wiring short-circuiting at least two of the
vertical signal lines in the optical black pixel region
with each other.

2. A solid state image sensor device according to claim 1, wherein at least one of the vertical signal lines in the optical black pixel region is excluded from being short-circuited with said at least two vertical signal lines by the wiring.

3. A solid state image sensor device according to

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7. A solid state image sensor device comprising:

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junction diode.

13. A solid state image sensor device according to claim 7, wherein the wiring causes levels of the readout signals of said plurality of vertical signal lines to be averaged.

14. A solid state image sensor device comprising:
an image sensing cell array portion including a plurality of unit cells, the unit cells being arranged in a matrix form on a semiconductor substrate, the image sensing cell array portion having a photo-sensitive pixel region, a first optical black pixel region and a second optical black pixel region having an optical black level different from that of the first optical black pixel region, the unit cells of the photo-sensitive pixel region for sensing an image, and the unit cells of the first and second optical black pixel regions for defining optical black levels;

a selecting circuit for selecting the unit cells of the image sensing cell array portion in a unit of one horizontal line of the image sensing cell array portion;

a plurality of vertical signal lines on which signals are read out from the unit cells selected by the selecting circuit; and

a wiring short-circuiting at least two of the vertical signal lines in the first and second optical black pixel regions with each other, one of which being

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15. A solid state image sensor device according to claim 14, wherein at least one of the vertical signal lines in the first and second optical black pixel regions is excluded from being short-circuited with said at least two vertical signal lines by the wiring.

16. A solid state image sensor device according to claim 14, wherein at least one of the vertical signal lines in the first and second optical black pixel regions, which is at the side of the photo-sensitive pixel region, is excluded from being short-circuited with said at least two vertical signal lines by the wiring.

17. A solid state image sensor device according to claim 14, wherein at least one of the vertical signal lines in the first and second optical black pixel regions, which is at the opposite side of the photo-sensitive pixel region, is excluded from being short-circuited with said at least two vertical signal lines by the wiring.

18. A solid state image sensor device according to claim 14, wherein at least one of the vertical signal lines in the first and second optical black pixel regions, which is at the side of the photo-sensitive pixel region, is excluded from being short-circuited with said at least two vertical signal lines by the

wiring, and wherein at least one of the vertical signal lines in the first and second optical black pixel regions, which is at the opposite side of the photo-sensitive pixel region, is excluded from being short-circuited with said at least two vertical signal lines by the wiring.

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19. A solid state image sensor device according to claim 14, wherein the unit cells of the first optical black pixel region include a PN junction diode as a photoelectric conversion element and the unit cells of the second optical black pixel region include no PN junction diode.

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20. A solid state image sensor device according to claim 14, wherein the wiring causes levels of the readout signals of said at least two vertical signal lines to be averaged.

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